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5	150	<p>((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not ((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (228/164,203,232,246,262.9).ccls.) or ((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not ((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (438/108,115,612-615,660,694).ccls.) or ((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not ((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/311,313-314,316-319).ccls.) or ((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 18:00
Search History	3/16/05 3:01:29 PM	<p>reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and</p>		
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6	23	(solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist)) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 18:00
7	1	(solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree) same (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist)) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 18:00
8	13	((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 18:00
-	1	("20030134233").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/03 09:19
-	289	(semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/03 09:29
-	12	((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 18:00
-	0	(solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree) same (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist)) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 17:59

-	17	(solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist)) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 17:59
-	1455	(resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/06 19:36
-	40	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist)))) and (430/311,313-314,316-319).ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:39

-	24	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/329-330).ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:40
-	46	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/311,313-314,316-319).ccls.) or (((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/329-330).ccls.)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:36

-	82	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (438/108,115,612-615,660,694).ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:35
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	126	<p>(((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/311,313-314,316-319).ccls.) or (((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/329-330).ccls.) or (((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (438/108,115,612-615,660,694).ccls.)</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:35
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-	10	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (228/164,203,232,246,262.9).ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:34
-	10	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (228/164,203,232,246,262.9).ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:35
-	82	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (438/108,115,612-615,660,694).ccls.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:36

	40	<p>((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/311,313-314,316-319).ccls.</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/07 13:40
	24	<p>((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/329-330).ccls.</p>	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 17:58

	136	((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (228/164,203,232,246,262.9).ccls.) or (((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (438/108,115,612-615,660,694).ccls.) or (((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and ((benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (resist or photoresist))) not (((semiconduct\$3 or wafer or silicon or "Si").ti,ab. and (resist or photoresist) same solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and (benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or BCB) same (resist or photoresist))) and (430/311,313-314,316-319).ccls.) or (((resist or photoresist or polyimide or benzocyclobutene or benzo adj cyclobutene or benzocyclo adj butene or benzo adj cyclo adj butene or BCB) same (transition adj temperature or "Tg" or "T.sub.g" or degrees) and (solder same (melt\$3 or heat\$3 or temperature or degrees or reflow\$3)) not ((solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/31 17:58
Search History C:\APPS\east\workspaces\10051906.qsp	3/16/04 3:01 PM 10051906.qsp	Heat\$3 or thermal\$3 or temperature or degree) and (solder\$3 near3 (ball\$3 or bump\$3) same (heat\$3 or thermal\$3 or temperature or degree)) and		